NHPV08S600G, NHPJ08S600G

Switch Mode Power Rectifiers

Features

- Ultrafast 30 Nanosecond Recovery Time
- 150°C Operating Junction Temperature
- High Voltage Capability of 600 V
- Low Forward Drop
- Low Leakage Specified @ 125°C Case Temperature
- These Devices are Pb-Free and RoHS Compliant
- NHPJ08S600G is a Halogen Free/BFR Free Device

Mechanical Characteristics:

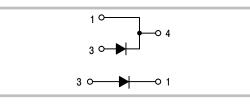
- Case: Epoxy, Molded
- Weight: 1.9 Grams (Approximately)
- Finish: All External Surfaces Corrosion Resistant and Terminal Leads are Readily Solderable
- Lead Temperature for Soldering Purposes: 260°C Max. for 10 Seconds

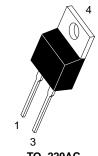


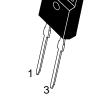
ON Semiconductor®

http://onsemi.com

PLANAR ULTRAFAST RECTIFIERS 8 A, 600 V



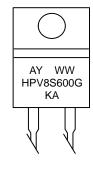




TO-220AC CASE 221B

TO-220 FULLPAK CASE 221AG

MARKING DIAGRAMS





А

= Assembly Location

/ = Year

WW = Work Week

G

= Pb-Free Package

KA

= Diode Polarity

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 2 of this data sheet.

^{*}For additional information on our Pb–Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

NHPV08S600G, NHPJ08S600G

MAXIMUM RATINGS

Rating			Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage		V _{RRM} V _{RWM} V _R	600	V
Average Rectified Forward Current (Rated V _R)	TO-220AC TO-220FP	I _{F(AV)}	8 A @ T _C = 130°C 8 A @ T _C = 95°C	Α
Peak Rectified Forward Current (Rated V _R , Square Wave, 20 kHz) TO-220AC TO-220FP		I _{FRM}	8 A @ T _C = 125°C 8 A @ T _C = 85°C	А
Nonrepetitive Peak Surge Current (Surge applied at rated load conditions halfwave, single phase, 60 Hz)			80	А
Operating Junction Temperature and Storage Temperature Range		T _J , T _{stg}	−55 to +150	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

THERMAL CHARACTERISTICS

Characteristic	Symbol	Value	Unit
NHPV08S600G: Thermal Resistance Junction-to-Case (Note 1)		1.5	°C/W
NHPJ08S600G: Thermal Resistance Junction-to-Case (Note 1)		4.25	°C/W

^{1.} Junction-to-Case shown as a typical value using a fixed 25°C cold plate boundary.

ELECTRICAL CHARACTERISTICS

Characteristic	Test Conditions	Symbol	Тур	Max	Unit
Instantaneous Forward Voltage (Note 2)	(i _F = 8 A, T _C = 125°C) (i _F = 8 A, T _C = 25°C)	VF	1.5 2.7	1.8 3.2	V
Instantaneous Reverse Current (Note 2)	(Rated DC Voltage, T _C = 125°C) (Rated DC Voltage, T _C = 25°C)	i _R	46 0.1	400 30	μΑ
Reverse Recovery Time	$(I_F = 0.5 \text{ A}, I_{rr} = 0.25 \text{ A}, I_R = 1 \text{ A})$ $(I_F = 1 \text{ A}, dI_F/dt = -50 \text{ A/}\mu\text{s}, V_R = 30 \text{ V})$	t _{rr}	- -	30 50	ns
Reverse Recovery Time Peak Reverse Recovery Current Total Reverse Recovery Charge Softness Factor	$(I_F = 8 \text{ A}, d_{IF}/d_t = -200 \text{ A/}\mu\text{s}, T_C = 25^{\circ}\text{C})$	t _{rr} I _{RM} Q _{rr} S	30 2.3 37 2	50 3 50 -	ns A nC -
Reverse Recovery Time Peak Reverse Recovery Current Total Reverse Recovery Charge Softness Factor	$(I_F = 8 \text{ A}, d_{IF}/d_t = -200 \text{ A/}\mu\text{s}, T_C = 125^{\circ}\text{C})$	t _{rr} I _{RM} Q _{rr} S	45 5.5 150 0.35	- - - -	ns A nC -
Forward Recovery Time Peak Forward Recovery Voltage	$(I_F = 8 \text{ A}, d_{IF}/d_t = 120 \text{ A/}\mu\text{s}, T_C = 25^{\circ}\text{C})$	t _{fr} V _{FP}	- -	200 6	ns V

^{2.} Pulse Test: Pulse Width = 300 μ s, Duty Cycle \leq 2.0%.

ORDERING INFORMATION

Device	Package	Shipping [†]
NHPV08S600G	TO-220AC (Pb-Free)	50 Units / Rail
NHPJ08S600G	TO-220FP (Pb-Free / Halide-Free)	50 Units / Rail

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NHPV08S600G, NHPJ08S600G

TYPICAL CHARACTERISTICS

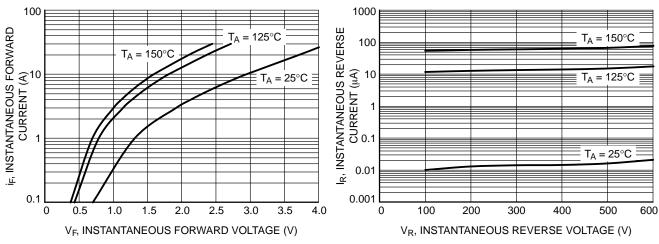
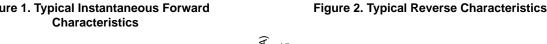


Figure 1. Typical Instantaneous Forward



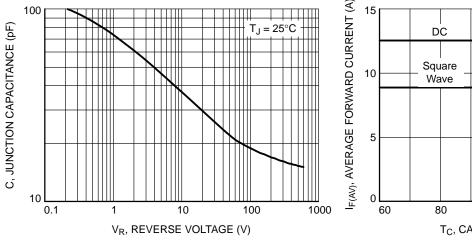


Figure 3. Typical Junction Capacitance

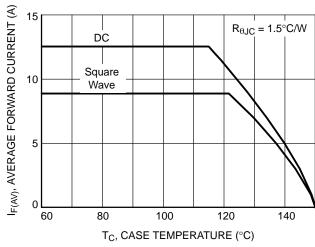


Figure 4. Current Derating TO-220AC

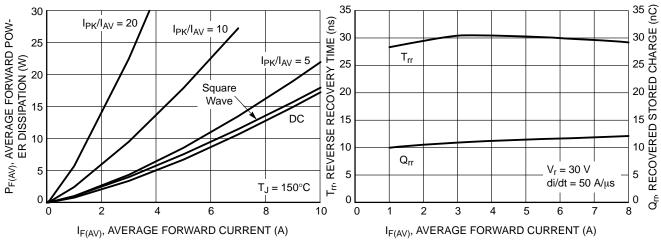


Figure 5. Forward Power Dissipation

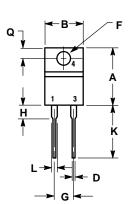
Figure 6. Typical Recovery Characteristics

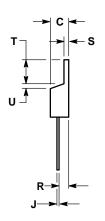
NHPV08S600G, NHPJ08S600G

PACKAGE DIMENSIONS

TO-220 TWO-LEAD

CASE 221B-04 ISSUE E



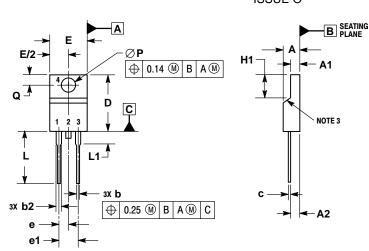


- DIMENSIONING AND TOLERANCING PER ANSI
- 2. CONTROLLING DIMENSION: INCH

	INCHES		MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
Α	0.595	0.620	15.11	15.75
В	0.380	0.405	9.65	10.29
С	0.160	0.190	4.06	4.82
D	0.025	0.035	0.64	0.89
F	0.142	0.161	3.61	4.09
Ð	0.190	0.210	4.83	5.33
H	0.110	0.130	2.79	3.30
J	0.014	0.025	0.36	0.64
K	0.500	0.562	12.70	14.27
٦	0.045	0.060	1.14	1.52
Q	0.100	0.120	2.54	3.04
R	0.080	0.110	2.04	2.79
S	0.045	0.055	1.14	1.39
Т	0.235	0.255	5.97	6.48
c	0.000	0.050	0.000	1.27

TO-220 FULLPAK, 2-LEAD

CASE 221AG **ISSUE O**



- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994. CONTROLLING DIMENSION: MILLIMETERS.

- CONTOUR UNCONTROLLED IN THIS AREA.
 DIMENSIONS D AND E DO NOT INCLUDE MOLD FLASH AND GATE PROTRUSIONS. MOLD FLASH AND GATE PROTRUSIONS NOT TO EXCEED 0.13 PER SIDE. THESE DIMENSIONS ARE TO BE MEASURED AT OUTERMOST EXTREME OF THE PLASTIC BODY
- DIMENSION b2 DOES NOT INCLUDE DAMBAR PROTRUSION. LEAD WIDTH INCLUDING PROTRUSION SHALL NOT EXCEED 2.00.

	MILLIMETERS		
DIM	MIN	MAX	
Α	4.30	4.70	
A1	2.50	2.90	
A2	2.50	2.70	
b	0.54	0.84	
b2	1.10	1.40	
С	0.49	0.79	
D	14.22	15.88	
E	9.65	10.67	
е	2.54	BSC	
e1	5.08 BSC		
H1	5.97	6.48	
L	12.70	14.73	
L1	ŀ	2.80	
P	3.00	3.40	
Q	2.80	3.20	

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